December 2014



# FCP190N65F N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET 650 V, 20.6 A, 190 mΩ

## Features

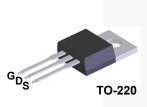
- 700 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 168 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 60 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 304 pF)
- 100% Avalanche Tested
- RoHS Compliant

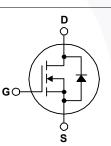
### Applications

- LCD / LED / PDP TV
- Solar Inverter
- AC DC Power Supply

# Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET II FRFET<sup>®</sup> MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter			FCP190N65F	Unit
V <sub>DSS</sub>	Drain to Source Voltage	Itage		650	V
V <sub>GSS</sub>	Gate to Source Voltage	- DC	- DC		V
		- AC	(f > 1 Hz)	±30	- V
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		20.6	А
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		13.1	- A
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	61.8	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		400	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		4.0	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		2.1	mJ	
dv/dt	MOSFET dv/dt			100	V/no
	Peak Diode Recovery dv/dt (Note 3)			50	V/ns
P <sub>D</sub>	Power Dissinction	(T <sub>C</sub> = 25°C)		208	W
	Power Dissipation	- Derate Above 25°C		1.67	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

### **Thermal Characteristics**

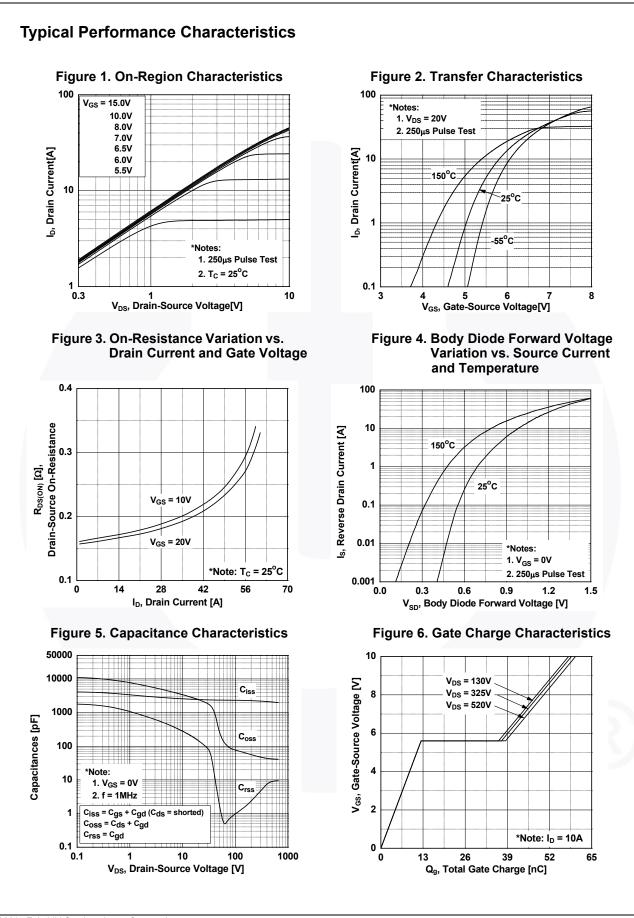
Symbol	Parameter	FCP190N65F	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.6	°C/W	
$R_{\thetaJA}$	rmal Resistance, Junction to Ambient, Max. 62.5		- 'C/w	

FCP190N		<b>ackage</b> TO-220	Packing Method Tube	Reel Size N/A	Tape Width N/A		Quantity 50 units	
Electrical	Characteristics T <sub>C</sub> = 25%	C unless o	otherwise noted.					
Symbol	Parameter		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charact	eristics							
-			V <sub>GS</sub> = 0 V, I <sub>D</sub> = 10 mA,	T <sub>.I</sub> = 25°C	650	-	-	
BV <sub>DSS</sub>	BV <sub>DSS</sub> Drain to Source Breakdown Voltage   ΔBV <sub>DSS</sub> / ΔT <sub>J</sub> Breakdown Voltage Temperature   Coefficient Coefficient		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$ $I_{D} = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		700	-	-	V
$\Delta BV_{DSS} / \Delta T_{J}$					-	0.72	-	V/ºC
1	Zero Gate Voltage Drain Current		$V_{DS}$ = 650 V, $V_{GS}$ = 0 V	,	-	-	10	μA
IDSS	Zero Gate Voltage Drain Current		V <sub>DS</sub> = 520 V, T <sub>C</sub> = 125 <sup>o</sup>	C	-	60	-	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current		$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V		-	-	±100	nA
On Charact	oristics							
		_					-	
V <sub>GS(th)</sub>	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_D = 2 \text{ mA}$		3	-	5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistar	nce	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		-	168	190	mΩ
9 <sub>FS</sub>	Forward Transconductance	_	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10 A		-	18	-	S
Dynamic C	haracteristics							
C <sub>iss</sub>	Input Capacitance				-	2425	3225	pF
C <sub>oss</sub>	Output Capacitance		$V_{DS}$ = 25 V, $V_{GS}$ = 0 V,	_	-	2110	2805	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		f = 1 MHz	-	-	105	155	pF
C <sub>oss</sub>	Output Capacitance		V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V	( f = 1 MHz	-	44	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance		$V_{DS} = 0 V \text{ to } 400 V, V_{GS}$		-	304	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		$V_{DS} = 380 \text{ V}, I_D = 10 \text{ A},$ $V_{GS} = 10 \text{ V}$			60	78	nC
Q <sub>gs</sub>	Gate to Source Gate Charge					12	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			(Note 4)	-	25	-	nC
∽gu ESR	Equivalent Series Resistance		f = 1 MHz		-	0.6	_	Ω
Switching (	Characteristics							
t <sub>d(on)</sub>	Turn-On Delay Time				-	25	60	ns
t <sub>r</sub>	Turn-On Rise Time		V <sub>DD</sub> = 380 V, I <sub>D</sub> = 10 A,		-	11	32	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		$V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 $\Omega$		-	62	134	ns
t <sub>f</sub>	Turn-Off Fall Time		-	(Note 4)	-	4.2	18	ns
			L			1		
Drain-Sour	ce Diode Characteristics						-	
I <sub>S</sub>	Maximum Continuous Drain to Sou				-	-	20.6	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source I				-	-	61.8	A
V <sub>SD</sub>	Drain to Source Diode Forward Vol	tage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 10 A		-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 10 A,	_	-	105	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		dI <sub>F</sub> /dt = 100 A/μs		-	515	-	nC

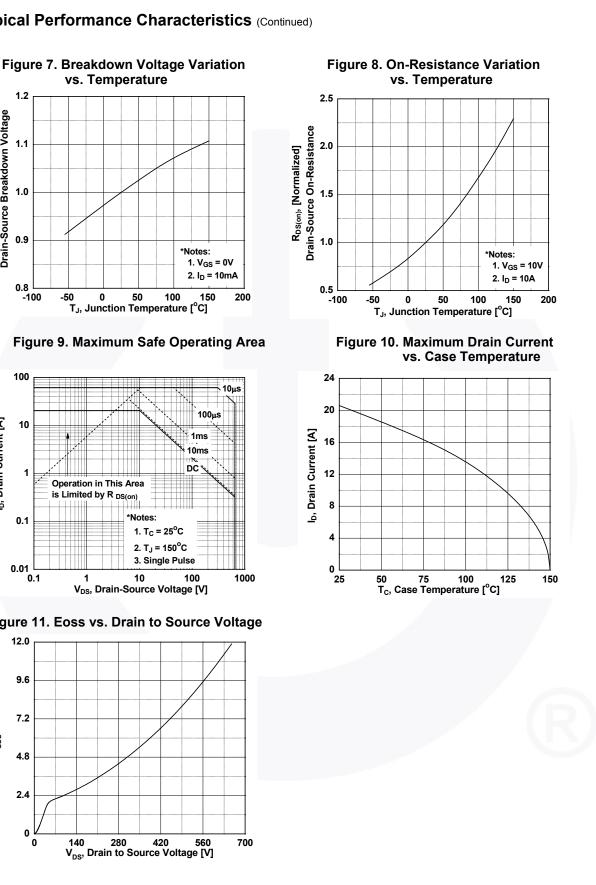
2

FCP190N65F — N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET





©2014 Fairchild Semiconductor Corporation FCP190N65F Rev. C2

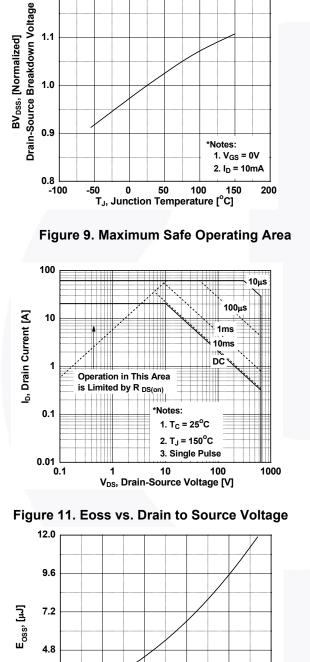


# Typical Performance Characteristics (Continued)

1.2

1.1

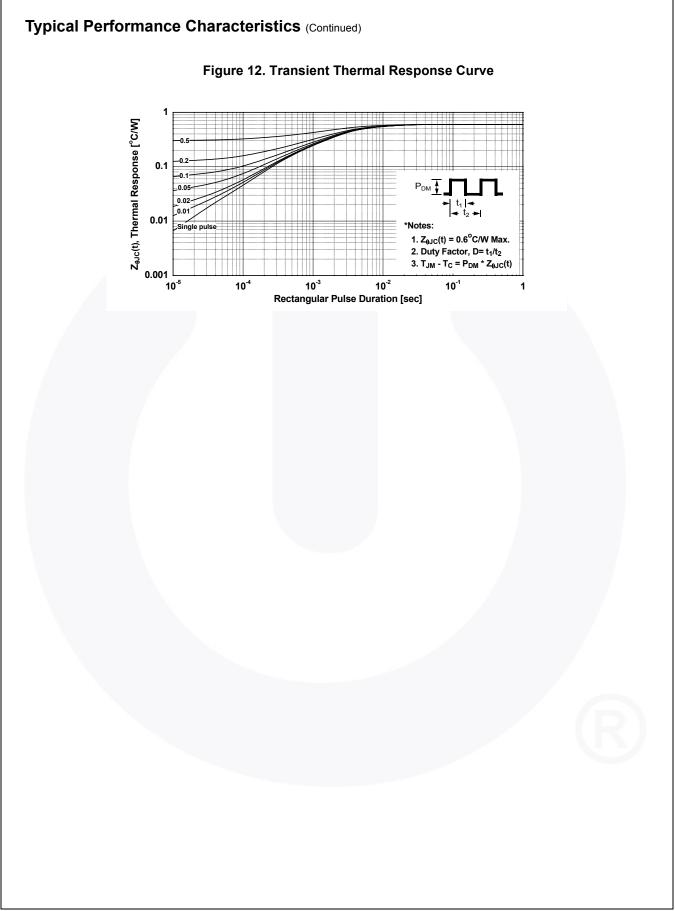
1.0



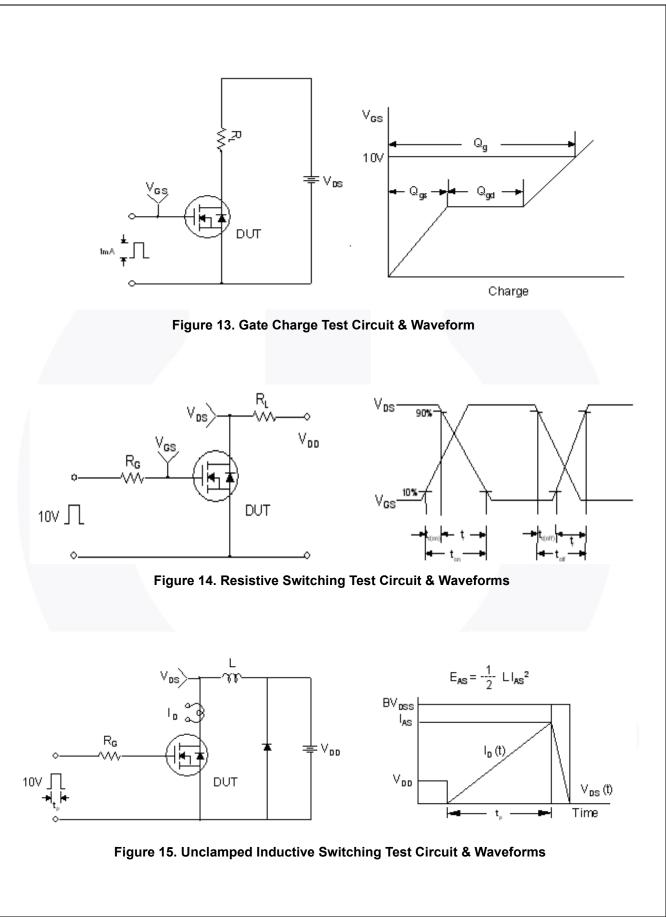
2.4

0

0

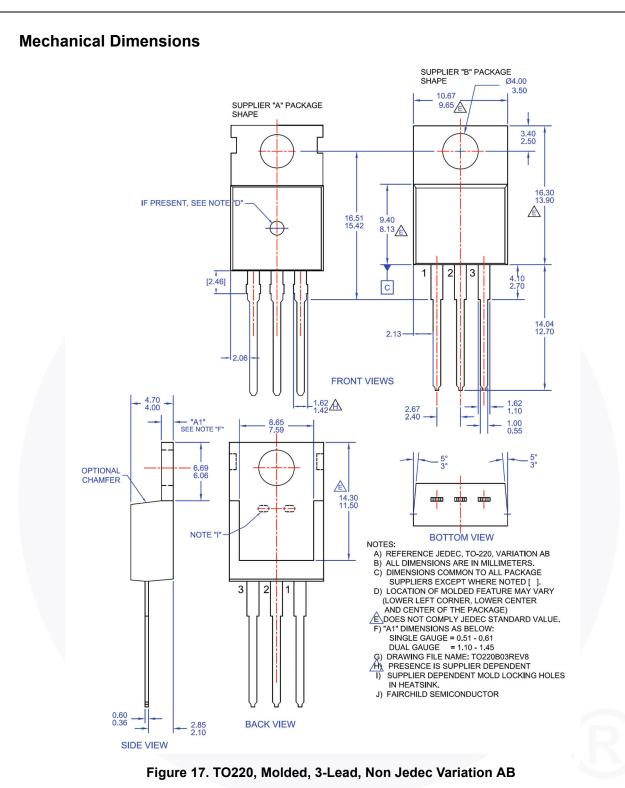


FCP190N65F — N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET



FCP190N65F — N-Channel SuperFET<sup>®</sup> II FRFET<sup>®</sup> MOSFET

DUT + ้อร I<sub>SD</sub> Driver  $R_{G}$ Same Type as DUT  $V_{DD}$  $\prod V_{GS}$ • dv/dt controlled by  $R_{G}$ •  $I_{SD}$  controlled by pulse period 1 Gate Pulse Width  $V_{GS}$ D = Gate Pulse Period 10V (Driver) IFM , Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current V<sub>DS</sub> (DUT) Body Diode Recovery dv/dt  $V_{SD}$  $V_{DD}$ Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN\_TT220-003



#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower <sup>TM</sup> AttitudeEngine <sup>TM</sup> Awinda <sup>®</sup> AX-CAP <sup>®</sup> * BitSiC <sup>TM</sup> Build it Now <sup>TM</sup> CorePLUS <sup>TM</sup> CrePOWER <sup>TM</sup> CROSSVOLT <sup>TM</sup> CTL <sup>TM</sup> Current Transfer Logic <sup>TM</sup> DEUXPEED <sup>®</sup> Dual Cool <sup>TM</sup> EcoSPARK <sup>®</sup> EfficentMax <sup>TM</sup> ESBC <sup>TM</sup> FificentMax <sup>TM</sup> ESBC <sup>TM</sup> Fairchild Semiconductor <sup>®</sup> Fairchild Semiconductor <sup>®</sup> FACT Quiet Series <sup>TM</sup> FACT <sup>®</sup> FastvCore <sup>TM</sup> FETBench <sup>TM</sup> FPS <sup>TM</sup>	F-PFS™ FRFET <sup>®</sup> Global Power Resource <sup>SM</sup> Green FPS™ Green FPS™ e-Series™ Gmax™ GTO™ IntelliMAX™ ISOPLANAR™ Marking Small Speakers Sound Loude and Better™ MegaBuck™ MICROCOUPLER™ MicroPak™ MicroPak2™ MicroPak2™ MillerDrive™ MotionMax™ MotionGrid® MTi® MTx® MVN® mWSaver® OptoHiT™ OPTOLOGIC®	OPTOPLANAR <sup>®</sup> → PowerTrench <sup>®</sup> PowerXS <sup>™</sup> Programmable Active Droop <sup>™</sup> QFET <sup>®</sup> QS <sup>™</sup> Quiet Series <sup>™</sup> RapidConfigure <sup>™</sup> apidConfigure <sup>™</sup> Saving our world, 1mW/W/kW at a time <sup>™</sup> SignalWise <sup>™</sup> SignalWise <sup>™</sup> SignalWise <sup>™</sup> SMART START <sup>™</sup> Solutions for Your Success <sup>™</sup> SPM <sup>®</sup> STEALTH <sup>™</sup> SuperSOT <sup>™</sup> -6 SuperSOT <sup>™</sup> -6 SuperSOT <sup>™</sup> -8 SupreMOS <sup>®</sup> SyncFET <sup>™</sup> Sync-Lock <sup>™</sup>	FinyBoost <sup>®</sup> TinyBoost <sup>®</sup> TinyBocst <sup>®</sup> TinyCalc <sup>TM</sup> TinyCalc <sup>TM</sup> TinyPower <sup>TM</sup> TinyPower <sup>TM</sup> TinyPWM
--	--	--	---

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT HTTP://WWW.FAIRCHILDSEMI.COM. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used here in:

- 1 Life support devices or systems are devices or systems which (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2 A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS**

#### Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		